

PE

As a below named inventor, I declare:
that I werily believe myself to be the original, first and sole (if only one
indired dual inventor is listed below) or an original, first and joint inventor
(if more than one individual inventor is listed below) of the invention in

SEMICONDUCTOR LASER MODULE AND ITS HEAT RELEASING METHOD AND IMAGE DISPLAY APPARATUS

the specification of which is attached hereto unless the following box is checked.

was filed on	as United	States Application
or PCT International	Application No	, and
was amended on	(if app	licable).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above. I acknowledge the duty to disclose information of which is material to patentability as defined in 37 CFR 1.56.

I hereby claim foreign priority benefits under 35 U.S.C. 119(a)-(d) or 365 (b) of any foreign application(s) for patent or inventor's certificate, or 35 U.S.C. 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed:

Country	Category	Application No.	Filing Date_	Claim
Japan	Patent	2003-121582	April 25, 2003	Yes

I hereby appoint the registrants as Customer Number 00909 of Pillsbury Winthrop LLP, telephone number (703-905-2000); 1600 Tysons Boulevard, McLean, Virginia 22102, or any one of them(see below label); my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith and with the resulting patent, and I hereby authorize them to delete from that Customer No. names of persons no longer with their firm and to add new persons of their firm to that Customer No., and to act and rely on instructions from and communicate directly with the person/assignee/attorney/firm/organization who/which first sends/sent this case to be represented unless/until I instruct the above firm and/or an attorney of that firm in writing to the contrary.



I declare further that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

DECLARATION FOR PATENT APPLICATION

I declare further that my mailing address is at c/o Intellectual Property Division, Toshiba Corporation, 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan; and that my citizenship and residence are as stated below next to my name:

7/

Date	Residence
MARZODOM	
Date: MAN. JU. 2004	
Citizen of: Japan	Kumagaya-shi, Japan
Date: MAR. 30.2004	_
Citizen of: Japan	Fukaya-shi, Japan
MAR. 30.2004	·
Citizen of: Japan	Kumagaya-shi, Japan
Date: MAR. 30.2004	
Citizen of: Japan	Fukaya-shi, Japan
Date:	
Citizen of: Japan	
Date:	
Citizen of: Japan	
•	
Date:	
Citizen of: Japan	
,	
Date:	
Citizen of: Japan	
	Date: MAR. 3 O. 2004 Citizen of: Japan Date: MAR. 3 O. 2004 Citizen of: Japan MAR. 3 O. 2004 Citizen of: Japan Date: MAR. 3 O. 2004 Citizen of: Japan Date: Citizen of: Japan